

## Small Signal Schottky Diode

### Features

- Integrated protection ring against static discharge
- Very low forward voltage
- Lead (Pb)-free component
- Component in accordance to RoHS 2002/95/EC and WEEE 2002/96/EC



94 9367

### Applications

- Applications where a very low forward voltage is required

### Mechanical Data

**Case:** DO35 Glass case

**Weight:** approx. 125 mg

**Cathode Band Color:** black

**Packaging Codes/Options:**

TR/10 k per 13" reel (52 mm tape), 50 k/box

TAP/10 k per Ammopack (52 mm tape), 50 k/box

### Parts Table

Part	Ordering code	Type Marking	Remarks
BAT85S	BAT85S-TR or BAT85S-TAP	BAT85S	Tape and Reel/Ammopack

### Absolute Maximum Ratings

$T_{amb} = 25\text{ }^{\circ}\text{C}$ , unless otherwise specified

Parameter	Test condition	Symbol	Value	Unit
Reverse voltage		$V_R$	30	V
Peak forward surge current	$t_p \leq 10\text{ ms}$	$I_{FSM}$	5	A
Repetitive peak forward current	$t_p \leq 1\text{ s}$	$I_{FRM}$	300	mA
Forward continuous current		$I_F$	200	mA
Average forward current	PCB mounting, $l = 4\text{ mm}$ ; $V_{RWM} = 25\text{ V}$ , $T_{amb} = 50\text{ }^{\circ}\text{C}$	$I_{FAV}$	200	mA

### Thermal Characteristics

$T_{amb} = 25\text{ }^{\circ}\text{C}$ , unless otherwise specified

Parameter	Test condition	Symbol	Value	Unit
Thermal resistance junction to ambient air	$l = 4\text{ mm}$ , $T_L = \text{constant}$	$R_{thJA}$	350	K/W
Junction temperature		$T_j$	125	$^{\circ}\text{C}$
Storage temperature range		$T_{stg}$	- 65 to + 150	$^{\circ}\text{C}$

## Electrical Characteristics

$T_{amb} = 25\text{ }^{\circ}\text{C}$ , unless otherwise specified

Parameter	Test condition	Symbol	Min	Typ.	Max	Unit
Forward voltage	$I_F = 0.1\text{ mA}$	$V_F$			240	mV
	$I_F = 1\text{ mA}$	$V_F$			320	mV
	$I_F = 10\text{ mA}$	$V_F$			400	mV
	$I_F = 30\text{ mA}$	$V_F$			500	mV
	$I_F = 100\text{ mA}$	$V_F$			800	mV
Reverse current	$V_R = 25\text{ V}$	$I_R$			2	$\mu\text{A}$
Diode capacitance	$V_R = 1\text{ V}, f = 1\text{ MHz}$	$C_D$			10	pF
Reverse Recovery Time	$I_F = 10\text{ mA}$ to $I_R = 10\text{ mA}$ to $i_R = 1\text{ mA}$	$t_{rr}$			5	ns

## Typical Characteristics

$T_{amb} = 25\text{ }^{\circ}\text{C}$ , unless otherwise specified

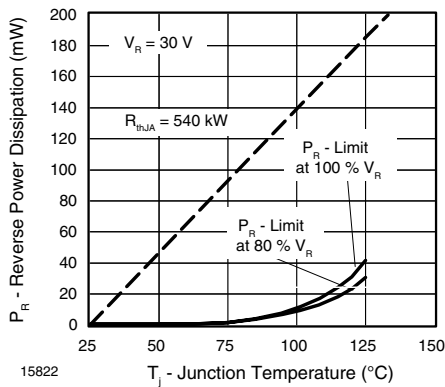


Figure 1. Max. Reverse Power Dissipation vs. Junction Temperature

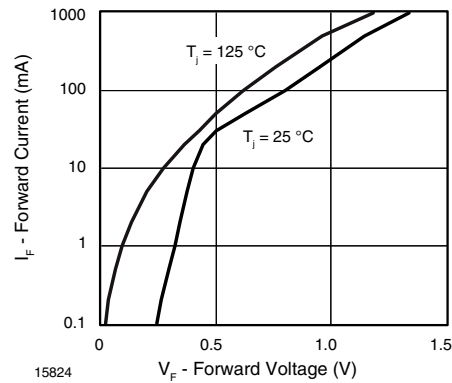


Figure 3. Forward Current vs. Forward Voltage

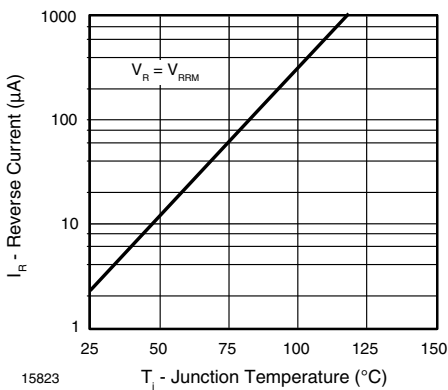


Figure 2. Reverse Current vs. Junction Temperature

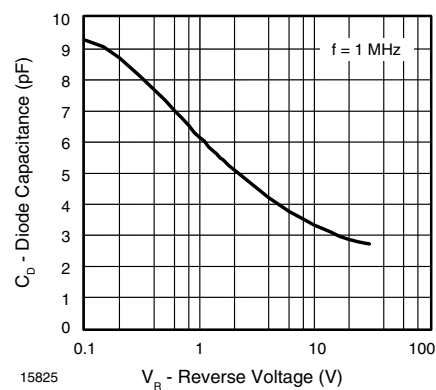
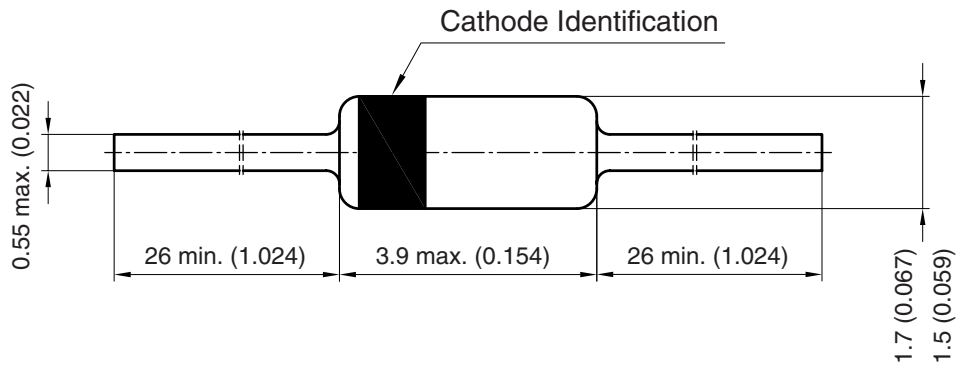


Figure 4. Diode Capacitance vs. Reverse Voltage

**Package Dimensions** in millimeters (inches): **DO35**



Rev. 6 - Date: 29. January 2007  
 Document no.: 6.560-5004.02-4  
 94 9366

### Ozone Depleting Substances Policy Statement

It is the policy of Vishay Semiconductor GmbH to

1. Meet all present and future national and international statutory requirements.
2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

Vishay Semiconductor GmbH has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively
2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA
3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

Vishay Semiconductor GmbH can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

We reserve the right to make changes to improve technical design  
and may do so without further notice.

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